

# EMIPAK 1B PressFit Power Module 1200 V Silicon Carbide Single Phase Bridge, 30 A

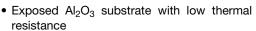


EMIPAK 1B (package example)

PRIMARY CHARACTERISTICS					
SINGLE PHASE BRIDGE					
$V_{RRM}$	1200 V				
V <sub>FM</sub> typical at 30 A	1.35 V				
I <sub>O</sub> at T <sub>SINK</sub> = 138 °C	30 A				
Q <sub>C</sub> typical at 30 A	118 nC				
Package	EMIPAK 1B				
Circuit configuration	SiC diodes full bridge				

### **FEATURES**

• SiC diode technology





- · Very high frequency operating
- · Low internal inductances
- · Qualified using AQG324 guideline as reference
- PressFit pins locking technology PATENT(S): <a href="www.vishav.com/patents">www.vishav.com/patents</a>
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **DESCRIPTION**

The EMIPAK 1B package is easy to use thanks to the PressFit pins. The exposed substrate provides improved thermal performance.

The optimized layout also helps to minimize stray parameters, allowing for better EMI performance.

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>J</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Operating junction temperature	TJ		175	°C	
Storage temperature range	T <sub>Stg</sub>		-40 to +150	C	
RMS isolation voltage	V <sub>ISOL</sub>	$T_J = 25$ °C, all terminals shorted, f = 50 Hz, t = 1 s	3500	V	
SINGLE PHASE BRIDGE					
Marian an arter to a month of bridge		180° conduction angle, T <sub>SINK</sub> = 25 °C	67	A	
Maximum output current of bridge	Io	180° conduction angle, T <sub>SINK</sub> = 80 °C	52		
Maximum peak one cycle forward non-repetitive surge current		10 ms sine or 6 ms rectangular pulse, $T_J = 25$ °C, no voltage reapplied	230	А	
		8.3 ms sine, T <sub>J</sub> = 25 °C, no voltage reapplied	241	Α	
Maximum 12t appability for fusing	I <sup>2</sup> t	No voltage reapplied, t = 10 ms	265	A <sup>2</sup> s	
Maximum I <sup>2</sup> t capability for fusing	1-1	No voltage reapplied, t = 8.3 ms	240 A		
Maximum I <sup>2</sup> √t capability for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms, no voltage reapplied	2645	A²√s	

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
D1 - D4 SINGLE PHASE BRIDGE	D1 - D4 SINGLE PHASE BRIDGE					
	V	I <sub>F</sub> = 30 A	-	1.35	1.82	V
Forward voltage drop (per diode)	$V_{FM}$	I <sub>F</sub> = 30 A, T <sub>J</sub> = 150 °C	-	1.79	-	v
Breakdown voltage (per diode)	$V_{BR}$	I <sub>R</sub> = 1 mA	1200	-	-	V
Reverse leakage current (per diode)		V <sub>R</sub> = 1200 V	-	75	800	
heverse leakage current (per diode)	IRM	V <sub>R</sub> = 1200 V, T <sub>J</sub> = 150 °C	-	900	-	μΑ

PATENT(S): <a href="https://www.vishay.com/patents">www.vishay.com/patents</a>

This Vishay product is protected by one or more United States and international patents.



<b>SWITCHING CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
D1 - D4 SINGLE PHASE BRIDGE						
Total capacitive charge (per diode)	$Q_{C}$	$V_R = 800 \text{ V}, \text{ dl/dt} = 500 \text{ A/}\mu\text{s}$	-	118	-	nC
Total capacitance (per diode) C	V <sub>R</sub> = 1 V, f = 1 MHz	-	2780	-	pF	
Total capacitance (per diode)	C	V <sub>R</sub> = 800 V, f = 1 MHz	-	253	-	ρг

INTERNAL NTC - THERMISTOR SPECIFICATIONS					
PARAMETER	SYMBOL	DL TEST CONDITIONS VALUE		UNITS	
Desistance	R <sub>25</sub>	T <sub>C</sub> = 25 °C	5000	0	
Resistance	R <sub>100</sub>	T <sub>C</sub> = 100 °C	493 ± 5 %	Ω	
B-value	B <sub>25/50</sub>	$R_2 = R_{25} \text{ exp. } [B_{25/50} (1/T2 - 1/298.15K))]$	3375 ± 5 %	K	
Maximum operating temperature			220	°C	
Dissipation constant			2	mW/°C	
Thermal time constant			8	S	

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS		
SINGLE PHASE BRIDGE - Thermal resistance junction to sink (per diode) (1) R <sub>thJS</sub> - 0.90				-	°C/W		
Case to sink thermal resistance (per module) (1)		-	0.1	-	C/VV		
Mounting torque (M4)		2	-	3	Nm		
Weight		-	28	-	g		

#### Note

 $<sup>^{(1)}</sup>$  Mounting surface flat, smooth, and greased,  $\lambda_{grease}$  = 0.67 W/mK

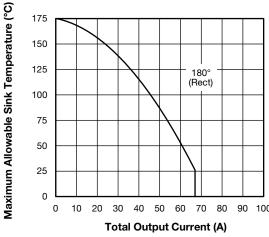


Fig. 1 - Current Rating Characteristics

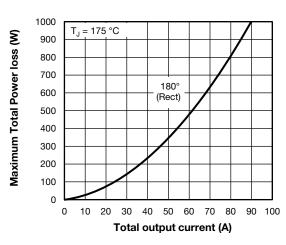


Fig. 2 - Total Power Loss Characteristics

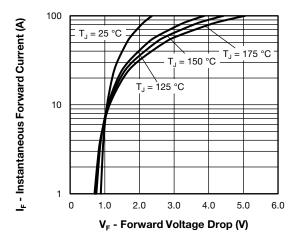


Fig. 3 - Typical Forward Voltage Drop vs. Instantaneous Forward Current (Per Diode)

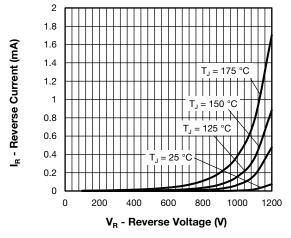


Fig. 4 - Typical Reverse Current vs. Reverse Voltage (Per Diode)

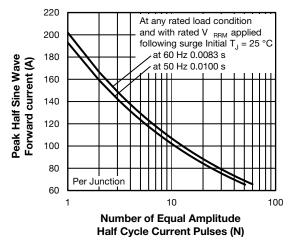


Fig. 5 - Maximum Non-Repetitive Surge Current (1)

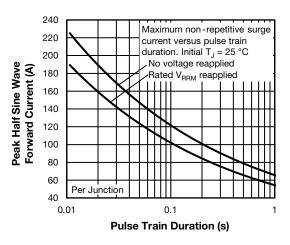


Fig. 6 - Maximum Non-Repetitive Surge Current (2)

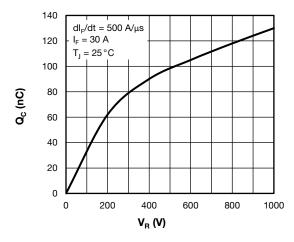


Fig. 7 - Total Capacitance Charge vs. Reverse Voltage (Per Diode)

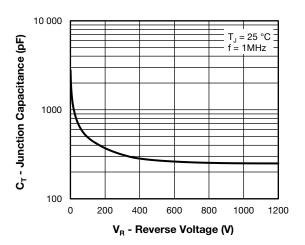


Fig. 8 - Typical Junction Capacitance vs. Reverse Voltage (Per Diode)



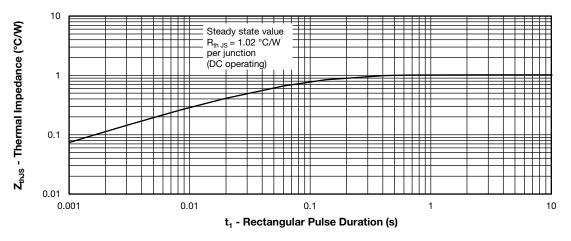
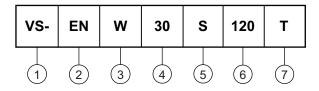


Fig. 9 - Z<sub>th,JS</sub> Thermal Impedance Characteristic (Per Diode)

### **ORDERING INFORMATION TABLE**

#### **Device code**



1 - Vishay Semiconductors product

Package indicator (EN = EMIPAK 1B)

3 - Circuit configuration (W = SiC diodes full bridge)

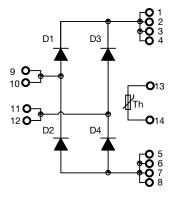
**4** - Current rating (30 = 30 A)

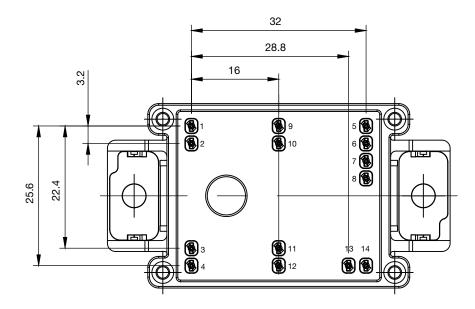
Die technology (S = SiC diode)

6 - Voltage rating (120 = 1200 V)

**7** - T = thermistor

### **CIRCUIT CONFIGURATION**



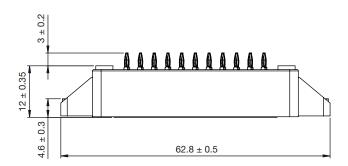


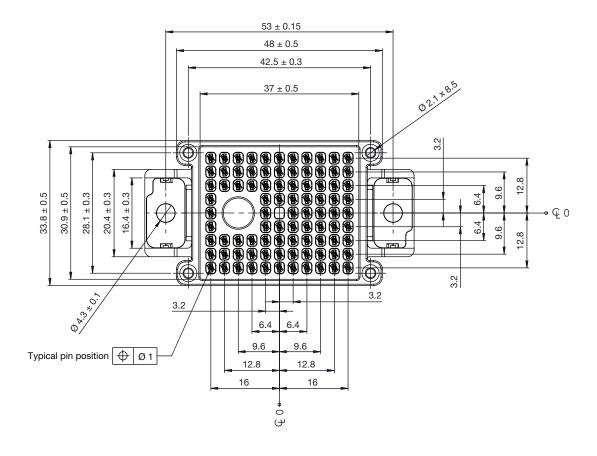
LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95558</u>				
Application Note	www.vishay.com/doc?95580			



## **EMIPAK-1B PressFit**

### **DIMENSIONS** in millimeters







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Vishay

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